

06-04-1998 P/1250-198 PATENT. 100727378 SHEET To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents 2. Name and Address of receiving party(ies): 1. Name of conveying party(ies): SMC Corporation 16-4 Shinbashi 1-chome, Minato-ku, Tokyo, Japan Hiroyasu GOTO; Akihiro HISAI; Minobu MATSUNAGA and Hiroshi KOBAYASHI and Dainippon Screen Mfg., Co., Ltd., 1-1 Tenjinkitamachi, Teranouchi-agaru 4-chome, Individuals Additional names(s) of conveying party(les) attached? NO Horikawa-dori, Kamikyo-ku, 3. Nature of conveyance: Tokyo, JAPAN Assignment Corporation-State Execution Date: April 21, 1998 Additional name(s) & address(es) attached? NO 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: April 21, 1998 A. Application No.(s) B. Patent No.(s) Additional numbers attached? No 5. Name and address of party to whom 6. Total number of documents involved: 1 correspondence concerning document should be mailed: OSTROLENK, FABER, GERB & SOFFEN, LLP \$ 40.00 7. Total fee (37 CFR 3.41): 1180 Avenue of the Americas Enclosed as part of Check No. 76284 New York, New York 10036-8403 In the event the actual fee is greater than the payment sub-mitted or is inadvertently not enclosed or if any additional fee use is not paid, the Patent and Trademark Office is authorized to charge the underpayment to Deposit Account No. 15-0700. DO NOT USE THIS SPACE 8. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. May 27, 1998 Weisburd Total number of pages including cover sheet, attachments, and document: 2

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PATENT REEL: 9218 FRAME: 0628

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PATENT APPLICATION ASSIGNMENT -SOLE OR JOINT INVENTORS EXECUTED OUTSIDE U.S.A.

WHEREAS, I (We), Hiroyas Hiroshi KOBAYASHI	u GOTO, Akihiro HISAI, Minobu MATSUNAGA and
	as assignor(s), have invented certain improvements i
APPARATUS FOR AND METHOD OF	THERMALLY PROCESSING SUBSTRATE
	for
which an application for United State April 21 and 22, 1998	s Letters Patent has been executed by me (us) signed on
Whenese (1) SMC Component	ion of 16-4 Shiphachi 1-chomo Minato-ku TOKYO
	ion of 16-4 Shinbashi 1-chome, Minato-ku, TOKYO EEN MFG. CO., LTD. of 1-1 Tenjinkitamachi
	rikawa-dori, Kamikyo-ku, KYOTO, JAPAN
	Control Mariana (ac. co.
as assignee, is desirous of acquiring	all right, title and interest in and to said invention an
any Patent that may be granted theref	or,
consideration, the receipt of which is hand all other countries in and to said invidivisional, continuation, substitute of therefor in the United States and all filling of said application, and all rid and Trademarks if hereby authorized and therefrom to said assignee herein, as a for myself (ourselves) and my (our) lecovenant without further remuneration, and other applications for Patent on safacts known to the undersigned respect interferences or other legal proceeding involved, to sign all lawful papers, make to assist assignee, is successors, assig	ration of One Dollar (\$1.00) and other good and valuable bereby acknowledged, I (We), as assignor(s), the United State cention and the aforesaid application for Patent, all original or reissue applications and patents applied for or granter other countries, including all rights of priority from the other countries, including all rights of priority from the other countries, including all rights of priority from the other countries, and the commissioner of Patent requested to issue all patents on said inventions or resultings all representatives, heirs and assigns do hereby agree and to execute and deliver all divisional, continuation, reissue aid inventions and all assigned or its representatives all ing said inventions, whenever requested, to testify in any ogs in which any of said applications or patents may become all rightful oaths, and to do generally everything necessary and nominees to obtain patent protection for said invention ries, the expenses incident to said applications to be borned.
Date: 22 Apr 1498	Hirizain Colo
	Hiroyasu GOTO
Date: 21 APR 1898	Akihiro Hisai
Date: 21 A(R/)/0	Akihiro HISAI
02 422 00k	mindry materings
Date: 22 APR 1998	Minobu MATSUNAGA
Date: 2/ APR 1998	Hiroshi Kobayashi
	Hiroshi KOBAYASHI
Date:	

RECORDED: 05/27/1998

LEGALIZATION RECOMMENDED
AMDT 41795

PATENT REEL: 9218 FRAME: 0629